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Execution Date: July 20, 2004

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4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: July 20, 2004

A. Patent Application No.(s)

B. Patent No.(s)

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5. Name and address of party to whom correspondence concerning document should be mailed:

Name: David M. Crompton

Address:

CROMPTON, SEAGER & TUFTE, LLC

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6. Total number of applications and patents involved: ___1__

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Docket No.: 1018.1207101

PATENT REEL: 015608 FRAME: 0995

ASSIGNMENT OF APPLICATION

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, the undersigned inventor(s) hereby:

1) Sell(s), assign(s) and transfer(s) to

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(hereinafter referred to as "ASSIGNEE"), which has a business office at

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a portion of the entire right, title, and interest in any and all inventions and improvements disclosed in, application(s) based upon, and Patent(s) granted upon the information which is disclosed in the application entitled:

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METHOD AND APPARATUS FOR FORMING GOLD PLATING

for a United States Letters Patent on July 20, 2004

(Application Serial No	filed on	. }
2) Authorize and request the Commission and all Letters Patents resulting frodivision, continuation, substitute of ASSIGNEE.	om said application, or any	
3) Agree to execute all papers and do which are reasonably necessary in consaid application, as well as any deriand/or the enforcement of patents res	nnection with the prosecution of ivative applications thereof	
Signed on the date(s) indicated l	oeside my(our) signature(s).	
1) Masaga Ichimura Name: Masaya Ichimura	Date:July_20, 2004	
2) Kanj: Masui Name: Kanji MASUI	Date:July 20, 2004	
Witness: Valsuya / akav	Date: July 20, 2004	
Witness: Vatsuya Takai Witness: Masahiro Takita	Date: July 20, 2004	

PATENT REEL: 015608 FRAME: 0996